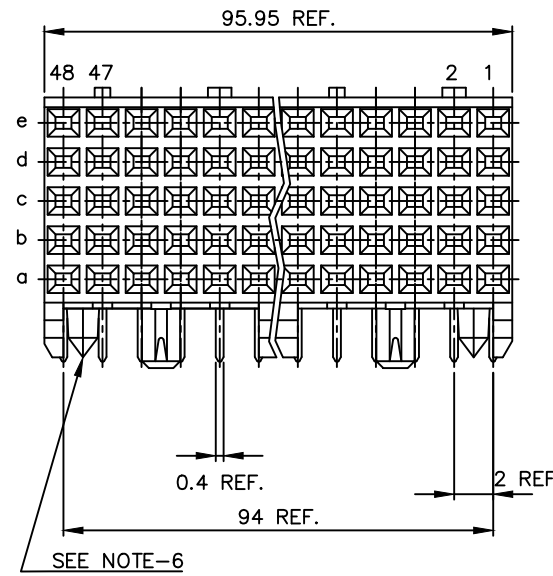
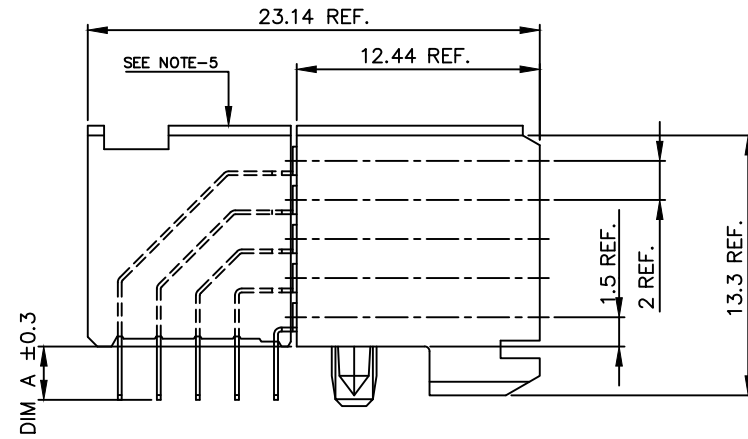
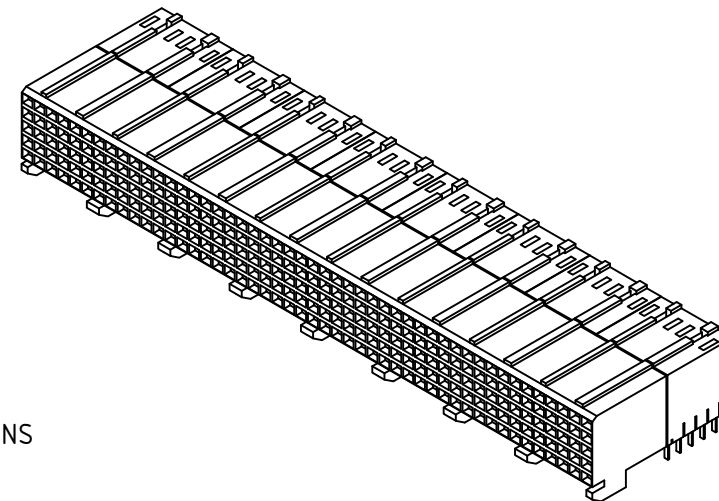
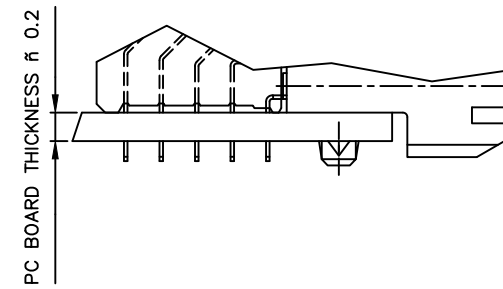
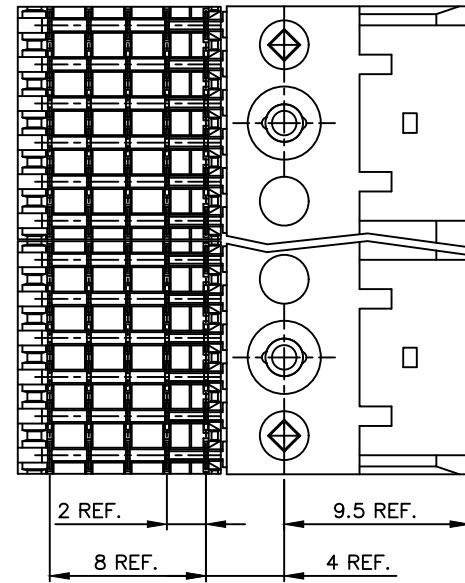
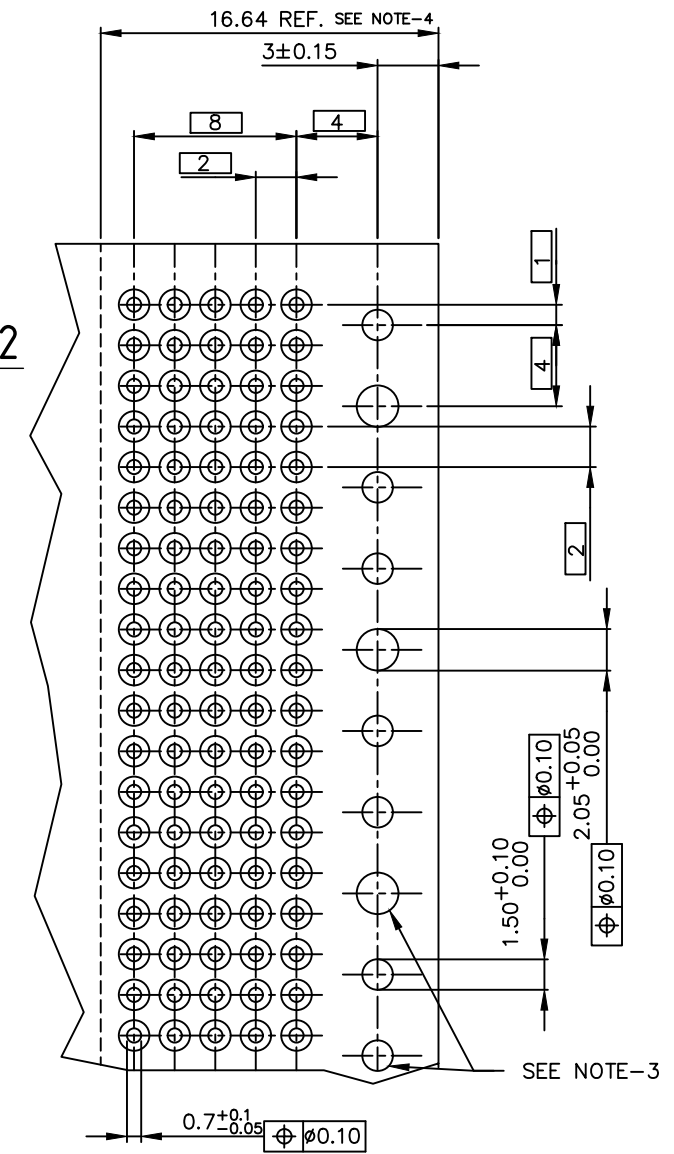


PC BOARD VERSIONS		
PRODUCT NR:	PCB THICKNESS	DIM A
85866-X02LF	1.6	2.90
85866-X12LF	2.4	3.53



REFER NOTE-2

85866-XY YLF



NOTES:

- MATERIAL : BODY : LCP UL94-V0
: CONTACT : COPPER ALLOY.
- FOR PLATING PERFORMANCE REFER DRAWING # 101594.08 \triangle
- INDICATED HOLES ARE UNPLATED.
- SET BACK FOR PRESS BLOCK.
- TOP SURFACE OF PRESS BLOCK MAY EXTEND UP TO 0.4MM HIGHER THAN HOUSING.
THIS MAY AFFECT THE TAIL LENGTH BEFORE APPLICATION TO A BOARD
- DIAMOND LOCATION PEG ARE ONLY EXISTED ON THE BOTH SIDES OF PRODUCT.
- THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-47- 0004.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260DEGREE PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION.
- A \triangle SYMBOL WILL BE NEXT TO ANY DIMENSION, VIEW, OR NOTE WHICH HAS BEEN MODIFIED WITH THE CURRENT DRAWING REVISION.

mat'l. code	NOTE 1	surface 58	tolerance	projection	product family
ltr	ecn no	dr	date	ISO 1302	METRAL
G	DG08-0171	TER	2008-08-26	tolerances unless otherwise specified	title
H	DG09-0068	CENH	2009-03-03	0.X±0.3	5 ROW R.A. S.T.B SIGNAL
J	ELX-I-38913	MINI	2020-10-23	0.XX±0.13	RECEPT.96mm MOD. P.P.
				0.XXX±0.050	dwg no
				angles	sheet 1 of 1
				linear	size
				0°±2°	A3
				dr	Amphenol
				R. VISSCHERS	FCI
				1994-10-05	
				enr	
				ARUN	
				2020-10-23	
				chr	
				ALEX BABU	
				2020-10-23	
				appd	
				SANOJ	
				2020-10-23	
sheet index	revision sheet	J			
		1			